# **Power MOSFET**

-20 V, -400 mA, P-Channel SOT-23 Package

## Features

- Low  $R_{DS(on)}$  Provides Higher Efficiency and Extends Battery Life  $R_{DSon} = 0.80 \Omega$ ,  $V_{GS} = -10 V$ 
  - $R_{DSon} = 1.10 \ \Omega, \ V_{GS} = -4.5 \ V$
- Miniature SOT-23 Surface Mount Package Saves Board Space
- Pb-Free Packages are Available

### Applications

- DC-DC Converters
- Computers
- Printers
- PCMCIA Cards
- Cellular and Cordless Telephones

### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	$V_{\text{DSS}}$	-20	V
Gate-to-Source Voltage - Continuous	V <sub>GS</sub>	±20	V
Continuous Drain Current @ $T_A$ = 25°C Pulsed Drain Current (t_p $\leq$ 10 $\mu s)$	I <sub>D</sub> I <sub>DM</sub>	-0.4 -1.0	A
Total Power Dissipation @ $T_A = 25^{\circ}C$ (Note 1)	PD	225	mW
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	– 55 to 150	°C
Thermal Resistance – Junction-to-Ambient	$R_{\thetaJA}$	556	°C/W
Source Current (Body Diode)	I <sub>S</sub>	0.4	А
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 s	ΤL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

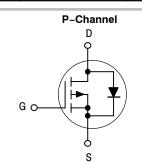
1. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2%.



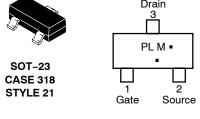
# **ON Semiconductor®**

#### http://onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> Typ	I <sub>D</sub> MAX
–20 V	550 mΩ @ −10 V	–400 mA



MARKING DIAGRAM & PIN ASSIGNMENT Drain



PL = Specific Device Code M = Date Code\* • = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

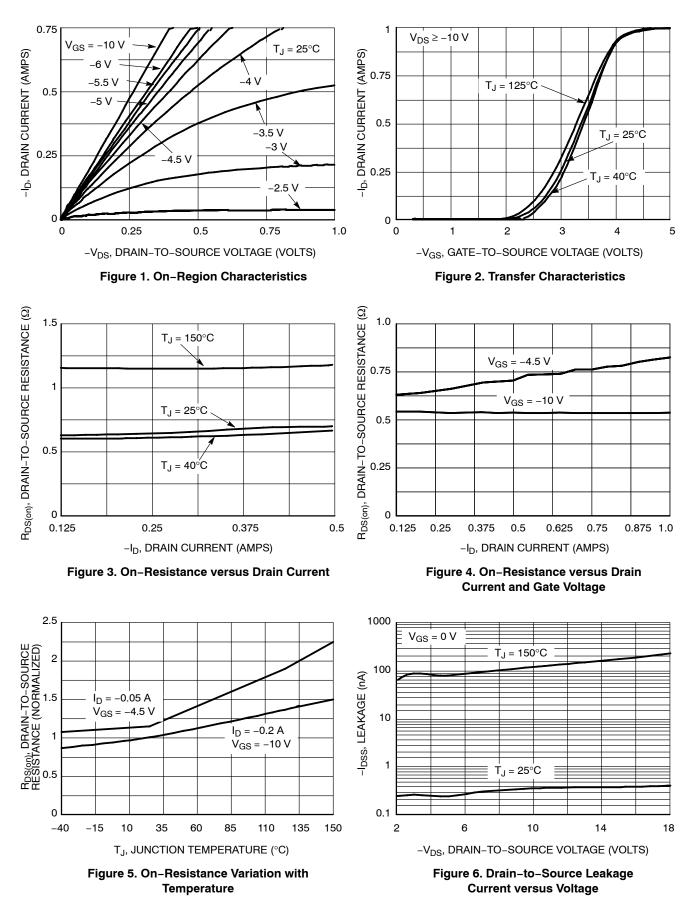
Device	Package	Shipping <sup>†</sup>
NTR0202PLT1	SOT-23	3000 Tape & Reel
NTR0202PLT1G	SOT-23 (Pb-Free)	3000 Tape & Reel
NTR0202PLT3	SOT-23	10,000 Tape & Reel
NTR0202PLT3G	SOT-23 (Pb-Free)	10,000 Tape & Reel

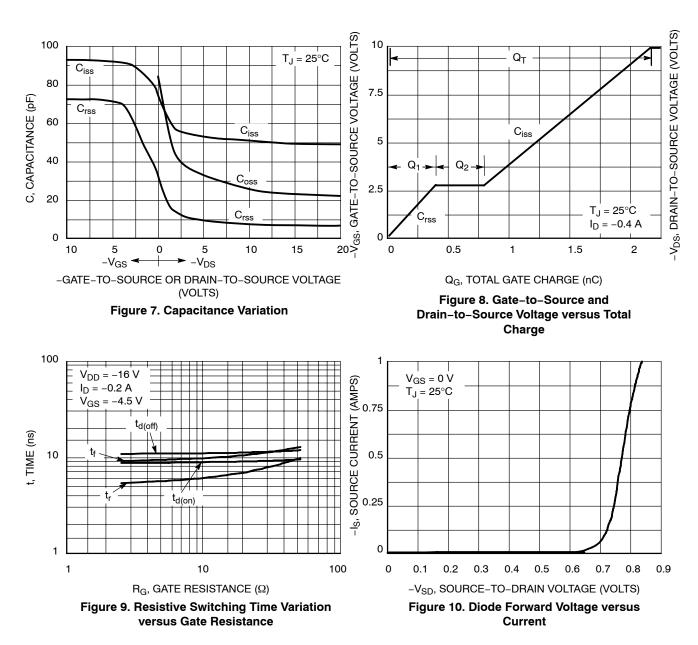
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = $25^{\circ}$ C unless otherwise noted)

Chara	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage (V <sub>GS</sub> = 0 V, I <sub>D</sub> = -10 μA) (Positive Temperature Coefficient)			-20	33		V mV/°C
Zero Gate Voltage Drain Current ( $V_{DS} = -20 V$ , $V_{GS} = 0 V$ , $T_J = 25^{\circ}C$ ) ( $V_{DS} = -20 V$ , $V_{GS} = 0 V$ , $T_J = 150^{\circ}C$ )		I <sub>DSS</sub>			-1.0 -10	μΑ
Gate-Body Leakage Current (V <sub>GS</sub> =	I <sub>GSS</sub>			±100	nA	
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage $(V_{DS} = V_{GS}, I_D = -250 \ \mu\text{A})$ (Negative Temperature Coefficient	V <sub>GS(th)</sub>	-1.1	-1.9 3.0	-2.3	V mV/°C	
Static Drain-to-Source On-Resistant ( $V_{GS}$ = -10 V, $I_D$ = -200 mA) ( $V_{GS}$ = -4.5 V, $I_D$ = -50 mA)	R <sub>DS(on)</sub>		0.55 0.80	0.80 1.10	Ω	
Forward Transconductance $(V_{DS} = -10 \text{ V}, I_D = -200 \text{ mA})$	9fs		0.5		Mhos	
DYNAMIC CHARACTERISTICS						
Input Capacitance		C <sub>iss</sub>		70		pF
Output Capacitance	(V <sub>DS</sub> = -5.0 V, V <sub>GS</sub> = 0 V, F = 1.0 MHz)	C <sub>oss</sub>		74		
Reverse Transfer Capacitance	· · · · · · · · · · · · · · · · · · ·	C <sub>rss</sub>		26		
	lote 3)			•		
Turn-On Delay Time		t <sub>d(on)</sub>		3.0		ns
Rise Time	(V <sub>DD</sub> = −15 V, I <sub>D</sub> = −200 mA,	t <sub>r</sub>		6.0		
Turn-Off Delay Time	$V_{GS} = -10 \text{ V}, \text{ R}_{G} = 6.0 \Omega$	t <sub>d(off)</sub>		18		
Fall Time		t <sub>f</sub>		4		
Total Gate Charge		Q <sub>TOT</sub>		2.18		nC
Gate-Source Charge	$(V_{DS} = -15 \text{ V}, \text{ I}_{D} = -200 \text{ mA}, V_{GS} = -10 \text{ V})$	Q <sub>GS</sub>		0.41		
Gate-Drain Charge		Q <sub>GD</sub>		0.40		
BODY-DRAIN DIODE CHARACTER	ISTICS (Note 2)					•
Diode Forward Voltage (Note 2) ( $I_S = -400 \text{ mA}, V_{GS} = 0 \text{ V}$ ) ( $I_S = -400 \text{ mA}, V_{GS} = 0 \text{ V}, T_J = 150^{\circ}\text{C}$ )		V <sub>SD</sub>		-0.8 -0.65	-1.0	V
Reverse Recovery Time	(I <sub>S</sub> = −1.0 A, V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/µs)	t <sub>rr</sub>		11.8		ns
		ta		9		]
	a15/ar - 100 / 4 μ0/	t <sub>b</sub>		3		1
Reverse Recovery Stored Charge	(I <sub>S</sub> = -1.0 A, V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/μs)	Q <sub>RR</sub>		0.007		μC

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperature.



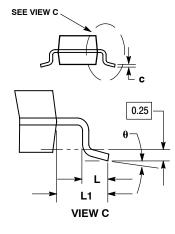


#### PACKAGE DIMENSIONS

## SOT-23 (TO-236) CASE 318-08

**ISSUE AN** 

D Ε  $H_E$ b



NOTES:

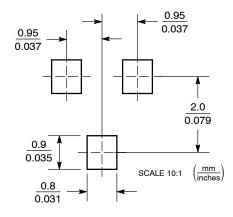
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF З.
- BASE MATERIAL 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104

STYLE 21: PIN 1. GATE

DRAIN 3.

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and 💷 are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 61312, Phoenix, Arizona 85082-1312 USA Phone: 480-829-7710 or 800-344-3860 Toll Free USA/Canada Fax: 480-829-7709 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Japan: ON Semiconductor, Japan Customer Focus Center 2-9-1 Kamimeguro, Meguro-ku, Tokyo, Japan 153-0051 Phone: 81-3-5773-3850

ON Semiconductor Website: http://onsemi.com

Order Literature: http://www.onsemi.com/litorder

For additional information, please contact your local Sales Representative.

<sup>2</sup> SOURCE